TECHNICAL DATA DATA SHEET 4151, REV. B

# LOW RDS HERMETIC POWER MOSFET - N-CHANNEL

#### **FEATURES:**

- 100 Volt, 0.011 Ohm, 90A MOSFET for Glidcop version
- Isolated Hermetic Metal Package
- Ultra Low R<sub>DS (on)</sub>
- Ceramic Seals with Glidcop leads (SHDCG224701)

# **MAXIMUM RATINGS**

ALL RATINGS ARE AT  $\rm T_{_{\rm C}}$  = 25°C UNLESS OTHERWISE SPECIFIED.

RATING	SYMBOL	MIN.	TYP.	MAX.	UNITS
GATE TO SOURCE VOLTAGE	$V_{GS}$	-	-	±20	Volts
ON-STATE DRAIN CURRENT	I <sub>D25</sub>	•	-	70*	Amps
PULSED DRAIN CURRENT	$I_{DM}$	ı	-	240	Amps
OPERATING AND STORAGE TEMPERATURE	$T_J/T_{STG}$	-55	-	+150	°C
TOTAL DEVICE DISSIPATION	$P_{D}$	•	-	210	Watts
THERMAL RESISTANCE, JUNCTION TO CASE	$R_{ heta JC}$	-	-	0.6	°C/W

Note: \* current limited by package; die rating is 90A

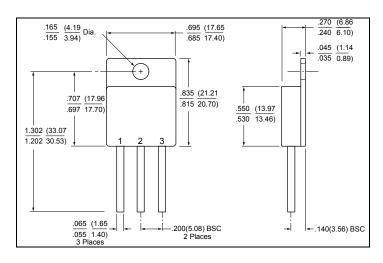
# **ELECTRICAL CHARACTERISTICS**

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNITS
DRAIN TO SOURCE BREAKDOWN VOLTAGE	BV <sub>DSS</sub>	100	-	-	Volts
$V_{GS} = 0V, I_D = 250\mu A$					
STATIC DRAIN TO SOURCE ON STATE RESISTANCE	R <sub>DS(ON)</sub>				Ω
$V_{GS} = 10V, I_{D} = 30A$	Glidcop	-	0.011	0.013	
	Version				
STATIC DRAIN TO SOURCE ON STATE RESISTANCE	R <sub>DS(ON)</sub>		0.040	0.045	Ω
$V_{GS} = 10V, I_D = 30A$	Standard Version	-	0.013	0.015	
GATE THRESHOLD VOLTAGE V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA		2		4	Volts
FORWARD TRANSCONDUCTANCE	V <sub>GS(th)</sub>	25	_		
$V_{DS} = 15V$ , $I_D = 30A$	g <sub>fs</sub>	25	_	-	S(1/Ω)
ZERO GATE VOLTAGE DRAIN CURRENT					
$V_{DS} = 0.8 \text{ x Max. rating}, V_{GS} = 0 \text{V}, T_{J} = 25^{\circ}\text{C}$	I <sub>DSS</sub>	_	_	1	μΑ
$T_{\rm J} = 125^{\circ}$ C	-500			50	pu t
GATE TO SOURCE LEAKAGE FORWARD V <sub>GS</sub> = 20V	I <sub>GSS</sub>	_	-	100	nA
GATE TO SOURCE LEAKAGE REVERSE V <sub>GS</sub> = -20V				-100	
TURN ON DELAY TIME $V_{DD} = 50V$	t <sub>d(ON)</sub>	-	20	30	
RISE TIME $I_D = 55A$	Ìtr		110	170	nsec
TURN OFF DELAY TIME V <sub>GS</sub> =10V					
	t <sub>d(OFF)</sub>		65	100	
FALL TIME $R_G = 2.5\Omega$	t <sub>f</sub>		100	150	
DIODE FORWARD VOLTAGE $I_F = 30A$ , $V_{GS} = 0V$	$V_{SD}$	-	1.0	1.2	Volts
Pulse test, $t \le 300 \mu s$ , duty cycle d $\le 2 \%$					
REVERSE RECOVERY TIME $T_J = 25^{\circ}C$ ,			70	4.40	
$I_F = 30A, V_R = 100V$	t <sub>rr</sub>	-	70	140	nsec
$di/dt = 100A/\mu sec$			0700		
INPUT CAPACITANCE $V_{GS} = 0 \text{ V},$	C <sub>iss</sub>	-	8700	-	
OUTPUT CAPACITANCE $V_{DS} = 25 \text{ V},$ REVERSE TRANSFER CAPACITANCE $f = 1.0 \text{MHz}$	Coss		740 450		pF
REVERSE TRANSFER CAPACITANCE f = 1.0MHz	$C_{rss}$	l	450		

#### **SENSITRON**

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## **MECHANICAL DIMENSIONS: in Inches / mm**



### **TO-258**

DEVICE TYPE	PIN-1	PIN-2	PIN-3
N-CHANNEL MOSFET	DRAIN	SOURCE	GATE
TO-258 PACKAGE			

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